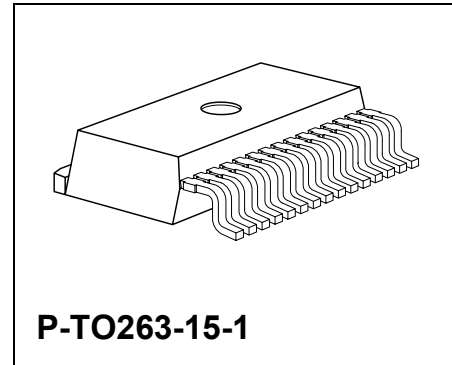


Target Data Sheet

1 Overview

1.1 Features

- Quad D-MOS switch driver
- Free configurable as bridge or quad-switch
- Optimized for DC motor management applications
- Low $R_{DS\ ON}$: 35 mΩ high-side switch, 15 mΩ low-side switch (typical values @ 25 °C)
- Maximum peak current: typ. tbd A @ 25 °C
- Very low quiescent current: typ. 5 μA @ 25 °C
- Small outline, thermal optimized PowerPak
- Load and GND-short-circuit-protection
- Operates up to 40 V
- Status flag for over temperature
- Open load detection in Off-mode
- Overtemperature shut down with hysteresis
- Internal clamp diodes
- Isolated sources for external current sensing
- Under-voltage detection with hysteresis



| Type | Ordering Code | Package |
|------------|---------------|--------------|
| BTS 781 GP | on request | P-TO263-15-1 |

1.2 Description

The **BTS 781 GP** is part of the **TrilithIC** family containing three dies in one package: One double high-side switch and two low-side switches. The drains of these three vertical DMOS chips are mounted on separated leadframes. The sources are connected to individual pins, so the **BTS 781 GP** can be used in H-bridge- as well as in any other configuration. The double high-side is manufactured in **SMART SIPMOS®** technology which combines low $R_{DS\ ON}$ vertical DMOS power stages with CMOS control circuitry. The high-side switch is fully protected and contains the control and diagnosis circuitry. To achieve low $R_{DS\ ON}$ and fast switching performance, the low-side switches are manufactured in **S-FET 2** logic level technology. The equivalent standard product is the **SPD30N06S2L-16**.

1.3 Pin Configuration (top view)

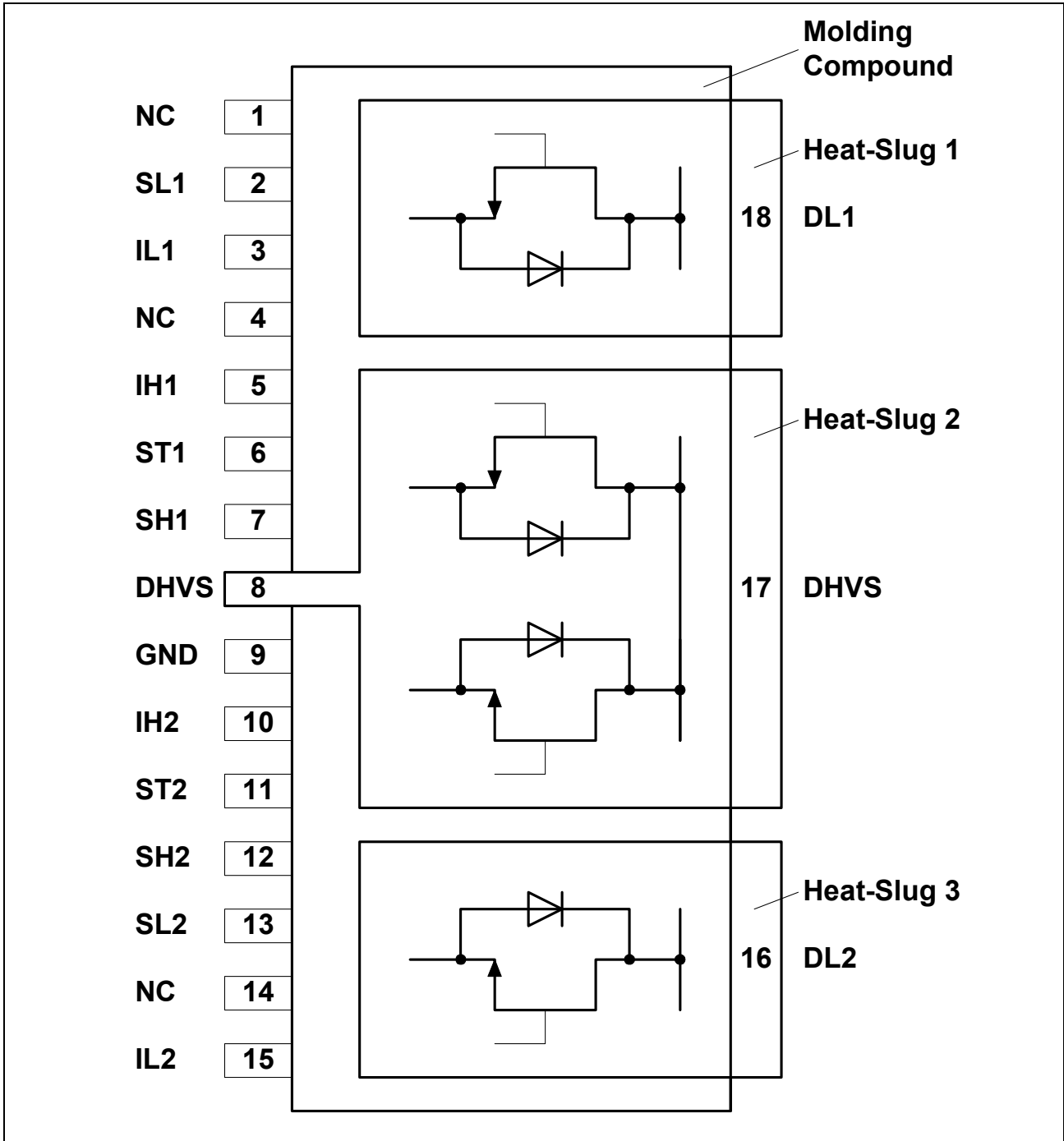


Figure 1

1.4 Pin Definitions and Functions

| Pin No. | Symbol | Function |
|-----------|-------------|--|
| 1 | NC | Not connected |
| 2 | SL1 | Source of low-side switch 1 |
| 3 | IL1 | Analog input of low-side switch 1 |
| 4 | NC | Not connected |
| 5 | IH1 | Digital input of high-side switch 1 |
| 6 | ST1 | Status of high-side switch 1; open Drain output |
| 7 | SH1 | Source of high-side switch 1 |
| 8 | DHVS | Drain of high-side switches and power supply voltage |
| 9 | GND | Ground of high-side switches |
| 10 | IH2 | Digital input of high-side switch 2 |
| 11 | ST2 | Status of high-side switch 2; open Drain output |
| 12 | SH2 | Source of high-side switch 2 |
| 13 | SL2 | Source of low-side switch 2 |
| 14 | NC | Not connected |
| 15 | IL2 | Analog input of low-side switch 2 |
| 16 | DL2 | Drain of low-side switch 2 Heat-Slug 3 or Heat-Dissipator |
| 17 | DHVS | Drain of high-side switches and power supply voltage Heat-Slug 2 or Heat-Dissipator |
| 18 | DL1 | Drain of low-side switch 1 Heat-Slug 1 or Heat-Dissipator |

Pins written in **bold type** need power wiring.

1.5 Functional Block Diagram

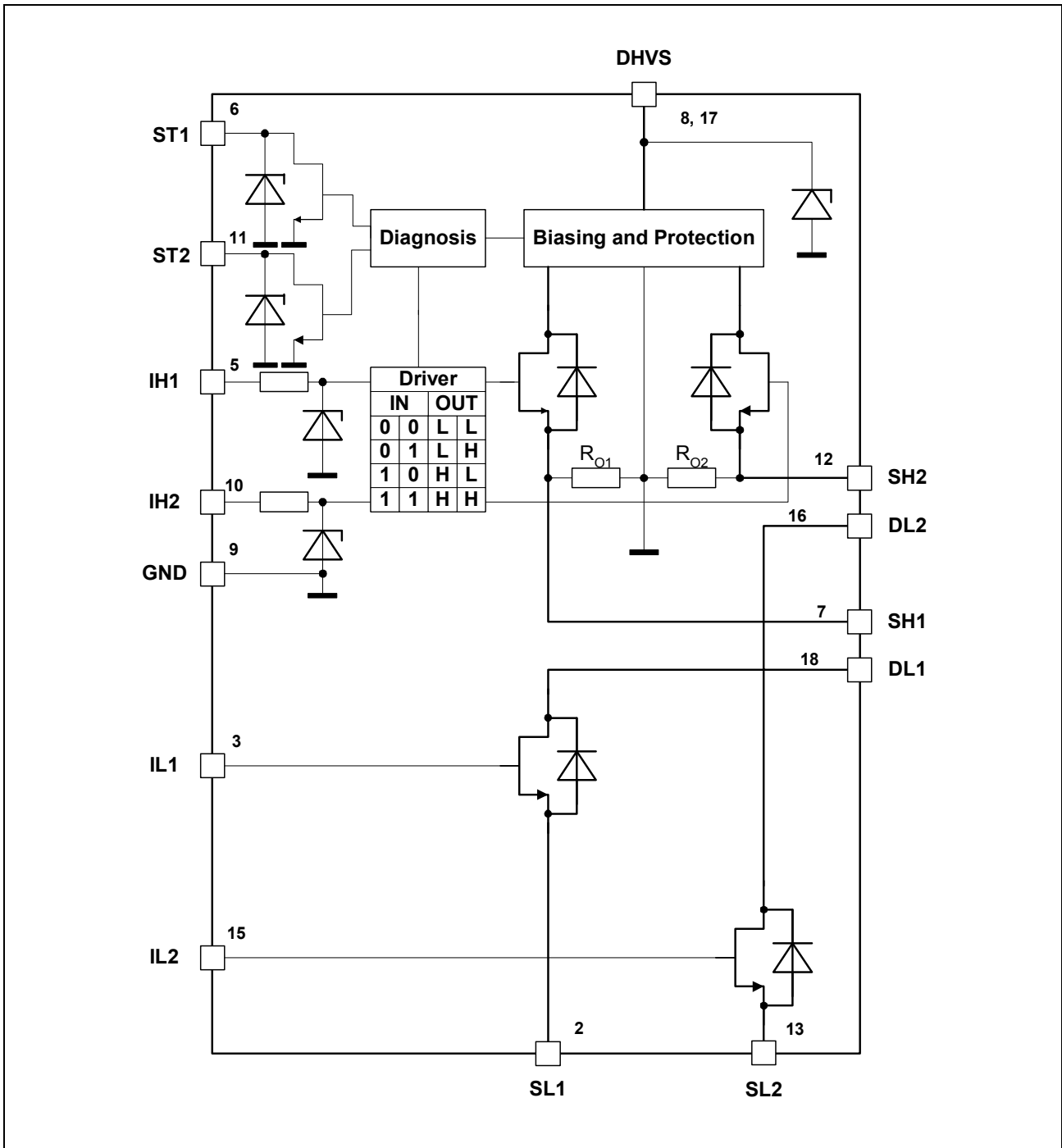


Figure 2
Block Diagram

1.6 Circuit Description

Input Circuit

The control inputs IH1,2 consist of TTL/CMOS compatible Schmitt-Triggers with hysteresis. Buffer amplifiers are driven by these stages and convert the logic signal into the necessary form for driving the power output stages. The inputs are protected by ESD clamp-diodes.

The inputs IL1 and IL2 are connected to the gates of the standard N-channel vertical power-MOS-FETs.

Output Stages

The output stages consist of a low $R_{DS\ ON}$ Power-MOS H-bridge. In H-bridge configuration, the D-MOS body diodes can be used for freewheeling when commutating inductive loads. If the high-side switches are used as single switches, positive and negative voltage spikes which occur when driving inductive loads are limited by integrated power clamp diodes.

Short Circuit Protection

The outputs are protected against

- output short circuit to ground
- overload (load short circuit).

An internal OP-Amp controls the Drain-Source-Voltage by comparing the DS-Voltage-Drop with an internal reference voltage. Above this trippoint the OP-Amp reduces the output current depending on the junction temperature and the drop voltage.

In the case of overloaded high-side switches the status output is set to low.

Overtemperature Protection

The high-side switches incorporate an overtemperature protection circuit with hysteresis which switches off the output transistors and sets the status output to low.

Undervoltage-Lockout (UVLO)

When V_S reaches the switch-on voltage V_{UVON} the IC becomes active with a hysteresis. The High-Side output transistors are switched off if the supply voltage V_S drops below the switch off value V_{UVOFF} .

Open Load Detection

Open load is detected by voltage measurement in Off state. If the output voltage exceeds a specified level the error flag is set with a delay.

Status Flag

The two status flag outputs are an open drain output with Zener-diode which require a pull-up resistor, c.f. the application circuit on page 15. ST1 and ST2 provide separate diagnosis for each high-side switch. Various errors as listed in the table “Diagnosis” are detected by switching the open drain output ST1/2 to low. Forward current in the integrated body diode of the highside switch may cause undefined voltage levels at the corresponding status output. The open load detection can be used to detect a short to V_s as long as both lowside switches are off and R_{OL} is disconnected from 5V by BCR192W.

2 Truthtable and Diagnosis (valid only for the High-Side-Switches)

| Flag | IH1 | IH2 | SH1 | SH2 | ST1 | ST2 | Remarks |
|--|--------|-----|---------|-----|-----|-----|--|
| | Inputs | | Outputs | | | | |
| Normal operation; identical with functional truth table | 0 | 0 | L | L | 1 | 1 | stand-by mode switch2 active switch1 active both switches active |
| | 0 | 1 | L | H | 1 | 1 | |
| | 1 | 0 | H | L | 1 | 1 | |
| | 1 | 1 | H | H | 1 | 1 | |
| Open load at high-side switch 1 | 0 | X | Z | X | 0 | 1 | detected |
| | 1 | X | H | X | 1 | 1 | |
| Open load at high-side switch 2 | X | 0 | X | Z | 1 | 0 | detected |
| | X | 1 | X | H | 1 | 1 | |
| Overtemperature high-side switch1 | 0 | X | L | X | 1 | 1 | detected |
| | 1 | X | L | X | 0 | 1 | |
| Overtemperature high-side switch2 | X | 0 | X | L | 1 | 1 | detected |
| | X | 1 | X | L | 1 | 0 | |
| Overtemperature both high-side switches | 0 | 0 | L | L | 1 | 1 | detected detected |
| | X | 1 | L | L | 1 | 0 | |
| | 1 | X | L | L | 0 | 1 | |
| Undervoltage | X | X | L | L | 1 | 1 | not detected |

Inputs:

0 = Logic LOW

1 = Logic HIGH

X = don't care

Outputs:

Z = Output in tristate condition

L = Output in sink condition

H = Output in source condition

X = Voltage level undefined

Status:

1 = No error

0 = Error

3 Electrical Characteristics

3.1 Absolute Maximum Ratings

$$-40\text{ °C} < T_j < 150\text{ °C}$$

| Parameter | Symbol | Limit Values | | Unit | Remarks |
|-----------|--------|--------------|------|------|---------|
| | | min. | max. | | |

High-Side-Switches (Pins DHVS, IH1,2 and SH1,2)

| | | | | | |
|--|--------------|-------|-----|----|----------------------------|
| Supply voltage | V_S | - 0.3 | 42 | V | - |
| Supply voltage for full short circuit protection | $V_{S(SCP)}$ | | tbd | V | - |
| HS-drain current | I_S | - 10 | * | A | $T_C = 125\text{ °C}$; DC |
| HS-input current | I_{IH} | - 5 | 5 | mA | Pin IH1 and IH2 |
| HS-input voltage | V_{IH} | - 10 | 16 | V | Pin IH1 and IH2 |

Note: * internally limited

Status Output ST (Pins ST1 and ST2)

| | | | | | |
|------------------------|----------|-------|-----|----|----------------|
| Status pull up voltage | V_{ST} | - 0.3 | 5.4 | V | - |
| Status Output current | I_{ST} | - 5 | 5 | mA | Pin ST1 or ST2 |

Low-Side-Switches (Pins DL1,2, IL1,2 and SL1,2)

| | | | | | |
|--|-----------|------|-----|---|--|
| Drain- source break down voltage | V_{DSL} | 55 | - | V | $V_{IL} = 0\text{ V}$; $I_D \leq 1\text{ mA}$ |
| LS-drain current | I_{DL} | -tbd | 20 | A | $T_C = 125\text{ °C}$; DC |
| LS-drain current $T_C = 85\text{ °C}$ | I_{DL} | - | 25 | A | $t < 100\text{ ms}$; $v < 0.1$ |
| | | - | tbd | A | $t < 1\text{ ms}$; $v < 0.1$ |
| LS-input voltage | V_{IL} | - 20 | 20 | V | Pin IL1 and IL2 |

Temperatures

| | | | | | |
|----------------------|-----------|------|-----|----|---|
| Junction temperature | T_j | - 40 | 150 | °C | - |
| Storage temperature | T_{stg} | - 55 | 150 | °C | - |

3.1 Absolute Maximum Ratings (cont'd)

$$-40\text{ °C} < T_j < 150\text{ °C}$$

| Parameter | Symbol | Limit Values | | Unit | Remarks |
|-----------|--------|--------------|------|------|---------|
| | | min. | max. | | |

Thermal Resistances (one HS-LS-Path active)

| | | | | | |
|--|--------------|---|-----|-----|--|
| LS-junction case | $R_{thjC L}$ | – | tbd | K/W | |
| HS-junction case | $R_{thjC H}$ | – | tbd | K/W | |
| Junction ambient $R_{thja} = T_{j(HS)}/(P_{(HS)}+P_{(LS)})$ | R_{thja} | – | 26 | K/W | device soldered to reference PCB with 6 cm ² cooling area |

ESD Protection (Human Body Model acc. MIL STD 883D, method 3015.7 and EOS/ESD assn. standard S5.1 - 1993)

| | | | | | |
|-------------------------|-----------|--|-----|----|------------------------------------|
| Input LS-Switch | V_{ESD} | | 0.5 | kV | |
| Input HS-Switch | V_{ESD} | | 1 | kV | |
| Status HS-Switch | V_{ESD} | | 2 | kV | |
| Output LS and HS-Switch | V_{ESD} | | 8 | kV | all other pins connected to Ground |

Note: Maximum ratings are absolute ratings; exceeding any one of these values may cause irreversible damage to the integrated circuit.

3.2 Operating Range

$$-40\text{ °C} < T_j < 150\text{ °C}$$

| Parameter | Symbol | Limit Values | | Unit | Remarks |
|-----------------------|-----------|--------------|------|------|-------------------------------------|
| | | min. | max. | | |
| Supply voltage | V_S | V_{UVOFF} | 42 | V | After V_S rising above V_{UVON} |
| Input voltages HS | V_{IH} | – 0.3 | 15 | V | – |
| Input voltages LS | V_{IL} | – 0.3 | 20 | V | – |
| Status output current | I_{ST} | 0 | 2 | mA | – |
| Junction temperature | T_{jHS} | – 40 | 150 | °C | – |

Note: In the operating range the functions given in the circuit description are fulfilled.

3.3 Electrical Characteristics

$I_{SH1} = I_{SH2} = I_{SL1} = I_{SL2} = 0 \text{ A}$; $-40 \text{ }^\circ\text{C} < T_j < 150 \text{ }^\circ\text{C}$; $8 \text{ V} < V_S < 18 \text{ V}$
 unless otherwise specified

| Parameter | Symbol | Limit Values | | | Unit | Test Condition |
|-----------|--------|--------------|------|------|------|----------------|
| | | min. | typ. | max. | | |

Current Consumption HS-switch

| | | | | | | |
|--|------------------------------|---|---|-----|---------------|--|
| Quiescent current | I_{SQ} | – | 5 | 8 | μA | $I_{H1} = I_{H2} = 0 \text{ V}$ $T_j = 25 \text{ }^\circ\text{C}$ |
| | | – | – | tbd | μA | $I_{H1} = I_{H2} = 0 \text{ V}$ |
| Supply current | I_S | – | 2 | 3.5 | mA | I_{H1} or $I_{H2} = 5 \text{ V}$ |
| | | – | 4 | 7 | mA | I_{H1} and $I_{H2} = 5 \text{ V}$ |
| Leakage current of highside switch | I_{SHLK} | – | – | 6 | μA | $V_{IH} = V_{SH} = 0 \text{ V}$ |
| Leakage current through logic GND in free wheeling condition | $I_{LKCL} = I_{FH} + I_{SH}$ | – | – | 10 | mA | $I_{FH} = 3 \text{ A}$ |

Current Consumption LS-switch

| | | | | | | |
|-----------------------------------|-----------|---|----|-----|---------------|---|
| Input current | I_{IL} | – | 10 | 100 | nA | $V_{IL} = 20 \text{ V}$; $V_{DSL} = 0 \text{ V}$ $T_j = 25 \text{ }^\circ\text{C}$ |
| Leakage current of lowside switch | I_{DLK} | – | – | 10 | μA | $V_{IL} = 0 \text{ V}$ $V_{DSL} = 40 \text{ V}$ |

Under Voltage Lockout (UVLO) HS-switch

| | | | | | | |
|--------------------------|-------------|-----|---|-----|------------|------------------------|
| Switch-ON voltage | V_{UVON} | – | – | 5 | V | V_S increasing |
| Switch-OFF voltage | V_{UVOFF} | 1.8 | – | 4.5 | V | V_S decreasing |
| Switch ON/OFF hysteresis | V_{UVHY} | – | 1 | – | V | $V_{UVON} - V_{UVOFF}$ |

3.3 Electrical Characteristics (cont'd)

$I_{SH1} = I_{SH2} = I_{SL1} = I_{SL2} = 0 \text{ A}$; $-40 \text{ }^\circ\text{C} < T_j < 150 \text{ }^\circ\text{C}$; $8 \text{ V} < V_s < 18 \text{ V}$
 unless otherwise specified

| Parameter | Symbol | Limit Values | | | Unit | Test Condition |
|-----------|--------|--------------|------|------|------|----------------|
| | | min. | typ. | max. | | |

Output stages

| | | | | | | |
|--|-----------------|---|-----|-----|------------|---|
| Inverse diode of high-side switch; Forward-voltage | V_{FH} | – | 0.8 | 1.2 | V | $I_{FH} = 3 \text{ A}$ |
| Inverse diode of lowside switch; Forward-voltage | V_{FL} | – | 0.8 | 1.2 | V | $I_{FL} = 3 \text{ A}$ |
| Static drain-source on-resistance of highside switch | $R_{DS\ ON\ H}$ | – | 26 | 35 | m Ω | $I_{SH} = 3 \text{ A}$ $T_j = 25 \text{ }^\circ\text{C}$ |
| Static drain-source on-resistance of lowside switch | $R_{DS\ ON\ L}$ | – | 13 | 15 | m Ω | $I_{SL} = 3 \text{ A}$; $V_{IL} = 5 \text{ V}$ $T_j = 25 \text{ }^\circ\text{C}$ |
| Static path on-resistance | $R_{DS\ ON}$ | – | – | 100 | m Ω | $R_{DS\ ON\ H} + R_{DS\ ON\ L}$ $I_{SH} = 3 \text{ A}$; |

Short Circuit of highside switch to GND

| | | | | | | |
|-------------------------|--------------|-----|----|-----|---|-------------------------------------|
| Initial peak SC current | $I_{SCP\ H}$ | tbd | 48 | tbd | A | $T_j = -40 \text{ }^\circ\text{C}$ |
| Initial peak SC current | $I_{SCP\ H}$ | tbd | 42 | tbd | A | $T_j = +25 \text{ }^\circ\text{C}$ |
| Initial peak SC current | $I_{SCP\ H}$ | 25 | 32 | tbd | A | $T_j = +150 \text{ }^\circ\text{C}$ |

Short Circuit of highside switch to V_s

| | | | | | | |
|---------------------------|-------|-----|----|-----|------------|-------------------------|
| Output pull-down-resistor | R_O | tbd | 14 | tbd | k Ω | $V_{DSL} = 3 \text{ V}$ |
|---------------------------|-------|-----|----|-----|------------|-------------------------|

Thermal Shutdown

| | | | | | | |
|--|-------------|-----|-----|-----|------------------|------------------------------------|
| Thermal shutdown junction temperature | $T_{j\ SD}$ | 155 | 180 | 190 | $^\circ\text{C}$ | – |
| Thermal switch-on junction temperature | $T_{j\ SO}$ | 150 | 170 | 180 | $^\circ\text{C}$ | – |
| Temperature hysteresis | ΔT | – | 10 | – | $^\circ\text{C}$ | $\Delta T = T_{j\ SD} - T_{j\ SO}$ |

3.3 Electrical Characteristics (cont'd)

$I_{SH1} = I_{SH2} = I_{SL1} = I_{SL2} = 0 \text{ A}$; $-40 \text{ }^\circ\text{C} < T_j < 150 \text{ }^\circ\text{C}$; $8 \text{ V} < V_S < 18 \text{ V}$
 unless otherwise specified

| Parameter | Symbol | Limit Values | | | Unit | Test Condition |
|-----------|--------|--------------|------|------|------|----------------|
| | | min. | typ. | max. | | |

Status Flag Output ST of highside switch

| | | | | | | |
|---|-----------------|-----|-----|-----|---------------|---------------------------|
| Low output voltage | V_{STL} | – | 0.2 | 0.6 | V | $I_{ST} = 1.6 \text{ mA}$ |
| Leakage current | I_{STLK} | – | – | 10 | μA | $V_{ST} = 5 \text{ V}$ |
| Zener-limit-voltage | V_{STZ} | 5.4 | | – | V | $I_{ST} = 1.6 \text{ mA}$ |
| Status change after positive input slope with open load | $t_{d(SToff+)}$ | – | – | 20 | μs | |
| Status change after negative input slope with open load | $t_{d(SToff-)}$ | – | – | 500 | μs | |
| Status change after positive input slope with overtemperature | $t_{d(SToff+)}$ | – | – | tbd | μs | |
| Status change after negative input slope with overtemperature | $t_{d(SToff-)}$ | – | – | tbd | μs | |

Note: times are guaranteed by design

Open load detection in Off condition

| | | | | | | |
|-----------------------------|---------------|-----|-----|-----|---|--|
| Open load detection voltage | $V_{OUT(OL)}$ | 1.8 | 2.8 | 3.5 | V | |
|-----------------------------|---------------|-----|-----|-----|---|--|

3.3 Electrical Characteristics (cont'd)

$I_{SH1} = I_{SH2} = I_{SL1} = I_{SL2} = 0 \text{ A}$; $-40 \text{ }^\circ\text{C} < T_j < 150 \text{ }^\circ\text{C}$; $8 \text{ V} < V_S < 18 \text{ V}$
 unless otherwise specified

| Parameter | Symbol | Limit Values | | | Unit | Test Condition |
|-----------|--------|--------------|------|------|------|----------------|
| | | min. | typ. | max. | | |

Switching times of highside switch

| | | | | | | |
|-----------------------------------|----------------|---|-----|-----|------------------------|---|
| Turn-ON-time; to 90% V_{SH} | t_{ON} | – | 100 | tbd | μs | $R_{Load} = 12 \text{ } \Omega$ $V_S = 12 \text{ V}$ |
| Turn-OFF-time; to 10% V_{SH} | t_{OFF} | – | 120 | tbd | μs | $R_{Load} = 12 \text{ } \Omega$ $V_S = 12 \text{ V}$ |
| Slew rate on V_{SH} | dV/dt_{ON} | – | 0.5 | – | $\text{V}/\mu\text{s}$ | $R_{Load} = 12 \text{ } \Omega$ $V_S = 12 \text{ V}$ |
| Slew rate off V_{SH} | $-dV/dt_{OFF}$ | – | 0.7 | – | $\text{V}/\mu\text{s}$ | $R_{Load} = 12 \text{ } \Omega$ $V_S = 12 \text{ V}$ |

Note: switching times are guaranteed by design

Switching times of low-side switch

| | | | | | | |
|---|-----------------|---|-----|-----|----|---|
| Turn-ON delay time; $V_{IL} = 5\text{V}$; $R_G = 16\Omega$ | $t_{d_ON_L}$ | – | | tbd | ns | resistive load $I_{SL} = 10 \text{ A}$; $V_S = 12 \text{ V}$ |
| Switch-ON time; $V_{IL} = 5\text{V}$; $R_G = 16\Omega$ | t_{ON_L} | – | | tbd | ns | resistive load $I_{SL} = 10 \text{ A}$; $V_S = 12 \text{ V}$ |
| Switch-OFF delay time; $V_{IL} = 5\text{V}$; $R_G = 16\Omega$ | $t_{d_OFF_L}$ | – | | tbd | ns | resistive load $I_{SL} = 10 \text{ A}$; $V_S = 12 \text{ V}$ |
| Switch-OFF time; $V_{IL} = 5\text{V}$; $R_G = 16\Omega$ | t_{OFF_L} | – | | tbd | ns | resistive load $I_{SL} = 10 \text{ A}$; $V_S = 12 \text{ V}$ |
| Input to source charge; | Q_{IS} | – | | tbd | nC | $I_{SL} = 10 \text{ A}$; $V_S = 40 \text{ V}$ |
| Input to drain charge; | Q_{ID} | – | | tbd | nC | $I_{SL} = 10 \text{ A}$; $V_S = 40 \text{ V}$ |
| Input charge total; | Q_I | – | | tbd | nC | $I_{SL} = 10 \text{ A}$; $V_S = 40 \text{ V}$ $V_{IL} = 0 \text{ to } 10 \text{ V}$ |
| Input plateau voltage; | $V_{(plateau)}$ | – | tbd | – | V | $I_{SL} = 10 \text{ A}$; $V_S = 40 \text{ V}$ |

Note: switching times and input charges are guaranteed by design

3.3 Electrical Characteristics (cont'd)

$I_{SH1} = I_{SH2} = I_{SL1} = I_{SL2} = 0 \text{ A}$; $-40 \text{ }^\circ\text{C} < T_j < 150 \text{ }^\circ\text{C}$; $8 \text{ V} < V_S < 18 \text{ V}$
 unless otherwise specified

| Parameter | Symbol | Limit Values | | | Unit | Test Condition |
|-----------|--------|--------------|------|------|------|----------------|
| | | min. | typ. | max. | | |

Control Inputs of highside switches IH 1, 2

| | | | | | | |
|--------------------------|-----------------------|-----|-----|-----|------------------|---------------------------|
| H-input voltage | $V_{IH \text{ High}}$ | – | – | 2.5 | V | – |
| L-input voltage | $V_{IH \text{ Low}}$ | 1 | – | – | V | – |
| Input voltage hysteresis | $V_{IH \text{ HY}}$ | – | 0.5 | – | V | – |
| H-input current | $I_{IH \text{ High}}$ | 15 | 30 | 60 | μA | $V_{IH} = 5 \text{ V}$ |
| L-input current | $I_{IH \text{ Low}}$ | 5 | 14 | 20 | μA | $V_{IH} = 0.4 \text{ V}$ |
| Input series resistance | R_I | 2.7 | 4 | 5.5 | $\text{k}\Omega$ | – |
| Zener limit voltage | $V_{IH \text{ Z}}$ | 5.4 | – | – | V | $I_{IH} = 1.6 \text{ mA}$ |

Control Inputs IL1, 2

| | | | | | | |
|------------------------|---------------------|-----|-----|-----|---|-------------------------|
| Gate-threshold-voltage | $V_{IL \text{ th}}$ | tbd | 1.7 | tbd | V | $I_{DL} = 1 \text{ mA}$ |
|------------------------|---------------------|-----|-----|-----|---|-------------------------|

Note: The listed characteristics are ensured over the operating range of the integrated circuit. Typical characteristics specify mean values expected over the production spread. If not otherwise specified, typical characteristics apply at $T_A = 25 \text{ }^\circ\text{C}$ and the given supply voltage.

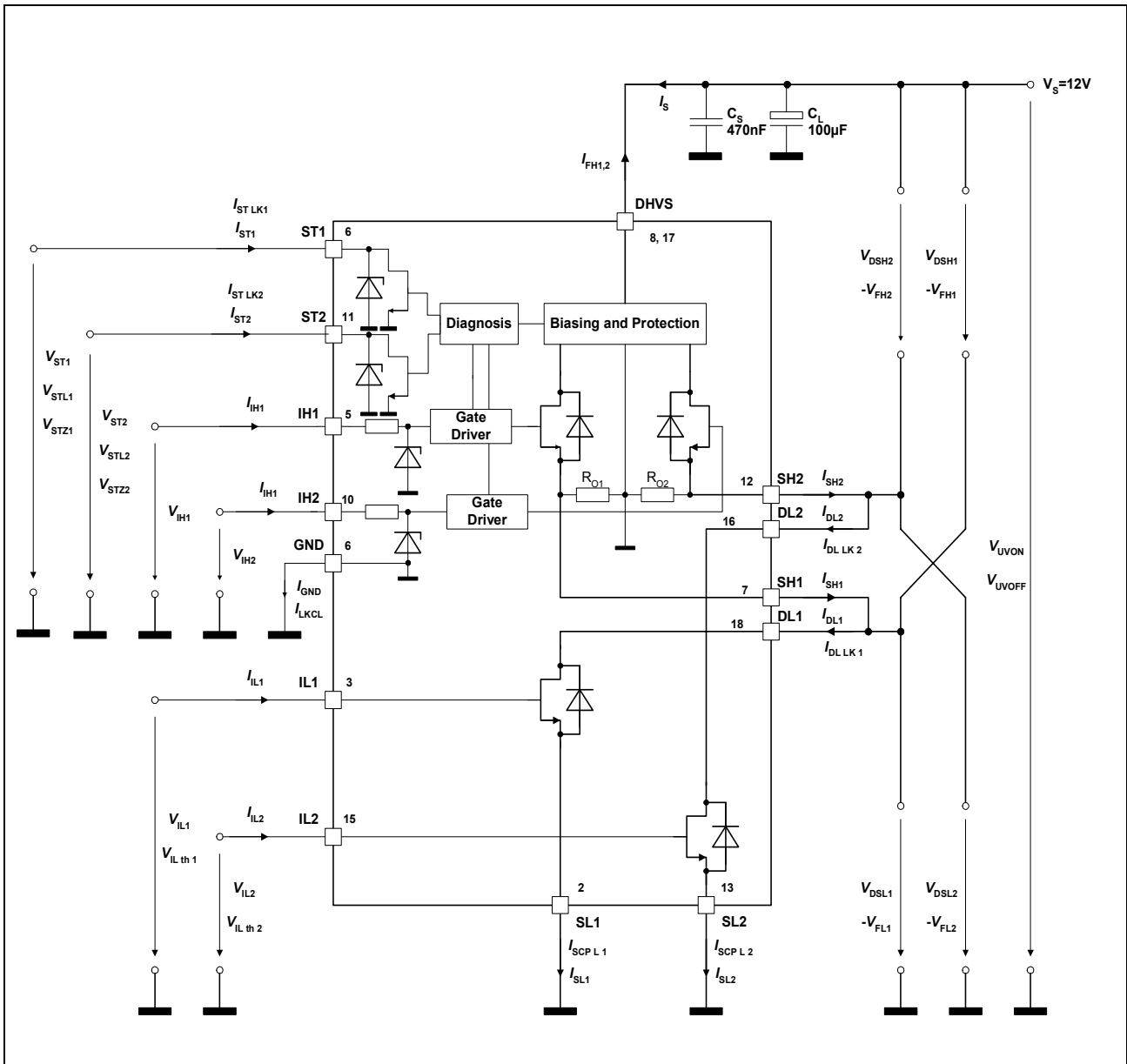


Figure 3
Test Circuit

| HS-Source-Current | Named during Short Circuit | Named during Leakage-Cond. |
|-------------------|----------------------------|----------------------------|
| $I_{SH1,2}$ | $I_{SCP H}$ | $I_{DL LK}$ |

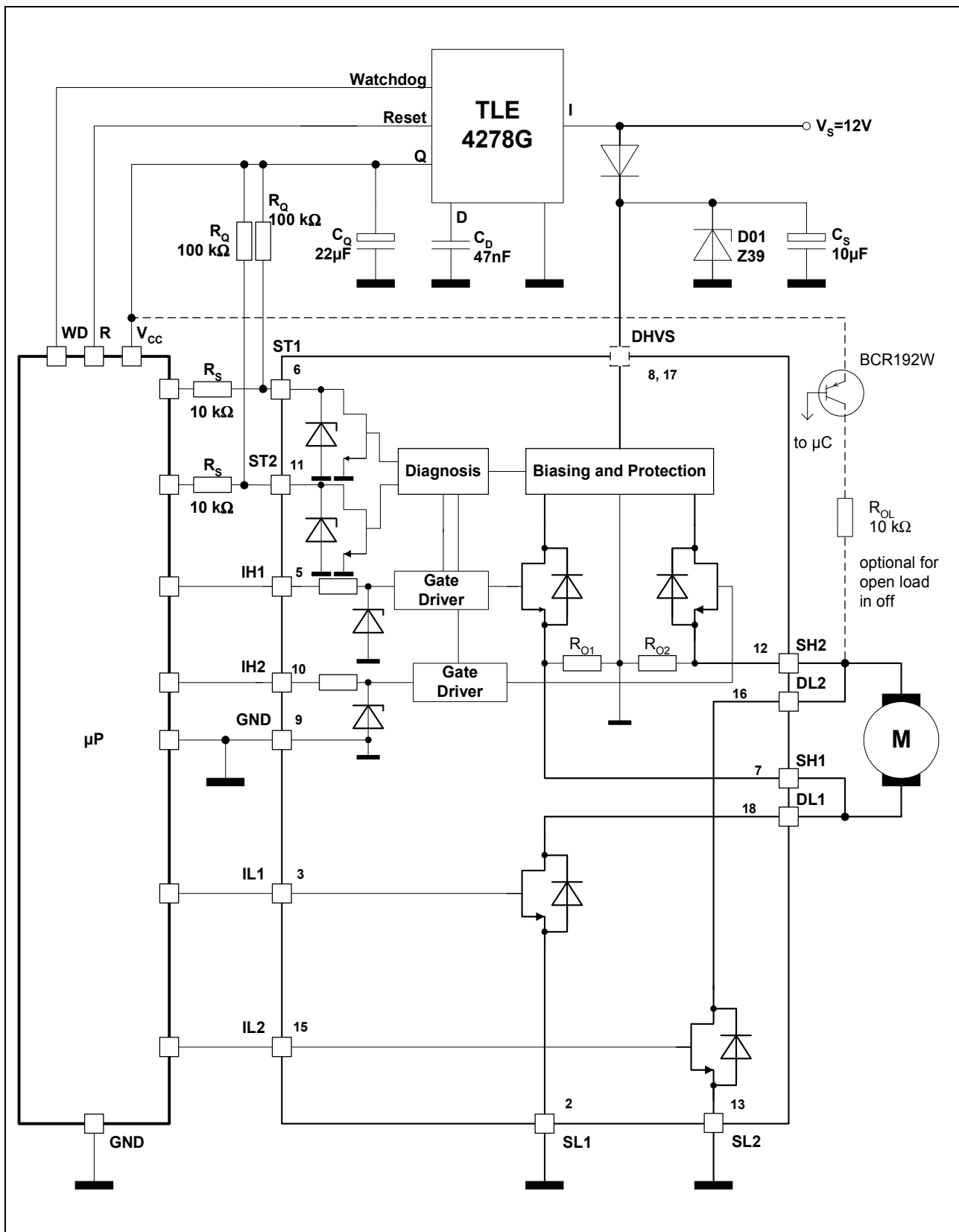
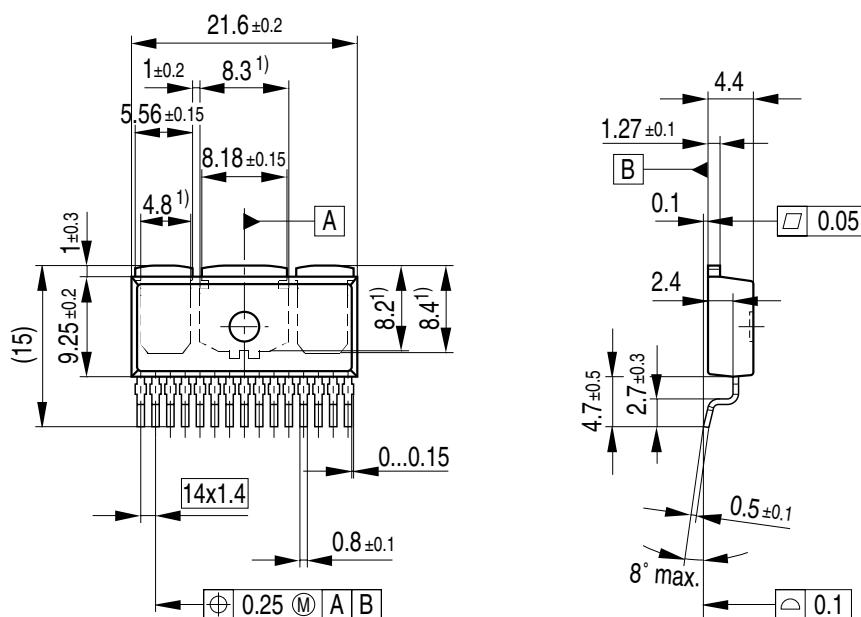


Figure 4
Application Circuit

4 Package Outlines

P-TO263-15-1 (Plastic Transistor Single Outline Package)



1) Typical
All metal surfaces tin plated, except area of cut.

GPT09151

GPS05123

Sorts of Packing

Package outlines for tubes, trays etc. are contained in our Data Book "Package Information".

SMD = Surface Mounted Device

Dimensions in mm

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